



## ABSTRACT

A production method of an electronic device comprising the steps of forming a stacked body by stacking green sheets ~~10~~ as sheets and electrode layers ~~12~~ as layers having a predetermined pattern and firing the stacked body. Before forming the stacked body, a blank pattern layer ~~24~~ having substantially the same thickness as that of the electrode layer is formed on a space portion of the electrode layer having a predetermined pattern. The electrode level difference absorbing print paste for forming the blank pattern layer ~~24~~ layer includes at least ceramic powder and a binder resin, and a polymerization degree of the binder resin included in the electrode level difference absorbing print paste is made equal to or more than that of a binder resin included in slurry for forming the green sheet. The binder resin of the electrode level difference absorbing print paste ~~includes a~~ includes polyvinyl butyral ~~resin, resin with~~ with a polymerization degree of the polyvinyl butyral resin is 1400 or more, a butyralation degree is 64 to 74 mol%, degree of 64 to 74 mol% and an acetalization degree is degree of 66 to 74 mol%.